

Metallized polypropylene dielectric capacitor with controlled self-healing.

Reinforced metallization developed for high impulse currents. Axial connections specially developed to reduce series inductance and to provide rigid mechanical mounting.

APPLICATIONS

IGBT protection
IGBT clamping

PACKAGING

Parallelipedic plastic case filled with thermosetting resin.
Outputs: Thin copper plate designed for M5 or M6 screw.

ELECTRICAL CHARACTERISTICS

Capacitance range C_n	0.47 μ F to 2.5 μ F
Tolerance on C_n	$\pm 10\%$
Rated DC voltage V_{ndc}	850 to 2000 V
Stray inductance	≤ 25 nH
RMS current	I_{rms} max. = up to 28 A The currents shown in the tables are maximum. It is necessary to respect the thermal limits of the dielectric 85°C see "Hot spot temperature calculation"
Insulation resistance	$R_i \times C \geq 30,000$ s
Impulse current	$I^2.t$ max. = up to 1.69 A ² s Spikes or peak currents in the capacitors may cause a deterioration of the bonding between the metallization and the connections. These bonds are capable of withstanding only a limited amount of energy for each spike. The table shows the maximum energy permitted in the form ($I^2.t$), where I is in Ampere, and t is in seconds.
Note: The formula ($I^2.t$) replaces dV/dt which is less easy to use as it is not an expression of energy ($I = C.dV/dt$). This type of capacitor has been designed to withstand high ($I^2.t$) values.	
Variation of capacitance with temperature	$\frac{\Delta C}{C} \leq \pm 2\%$ between -40 and 85°C
Climatic category	40/085/56 (IEC 68)
Test voltage between terminals @ 25°C	2 x V_{ndc} during 10s
Withstanding voltage between terminals and case @ 25°C	@ 3 kVrms @ 50 Hz during 1 min.

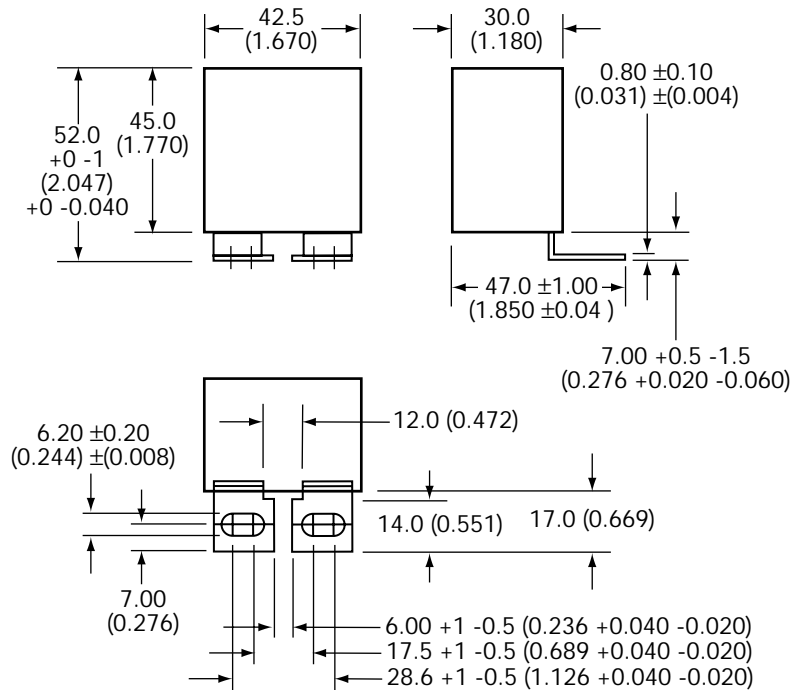
Medium Power Film Capacitors



FSB

DESIGN

Plastic case resin filled
Dimensions: millimeters (inches)



General Tolerances: ±0.50 mm (±0.020)

Capacitance (μF)	(I ² t) (A ² s)	I _{rms max.} (A)	R _s (mΩ)	R _{th} (°C/W)	Part Number
FSB 850V					
	V _{ndc} = 850V	V _{peak} = 1200V	V _{rms} = 450V	V _S = 1500V	
2	0.99	25	3.4	19.1	FSB16B0205K--
2.2	1.19	28	3.1	18.6	FSB16B0225K--
2.5	1.54	28	2.7	17.8	FSB16B0255K--
FSB 1200V					
	V _{ndc} = 1200V	V _{peak} = 1600V	V _{rms} = 560V	V _S = 2000V	
1	1.47	25	3.6	17.2	FSB16U0105K--
1.2	1.69	26	3.4	17.5	FSB16U0125K--
1.5	1	26	3.4	17.5	FSB16U0155K--
FSB 2000V					
	V _{ndc} = 2000V	V _{peak} = 2400V	V _{rms} = 700V	V _S = 2600V	
0.47	0.41	22	6.3	19.4	FSB16N0474K--
0.56	0.62	23	5.2	17.9	FSB16N0564K--
0.68	0.91	24	4.4	17.3	FSB16N0684K--

PROTECTION

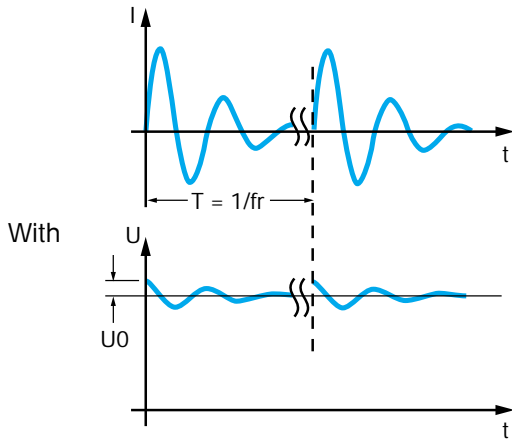
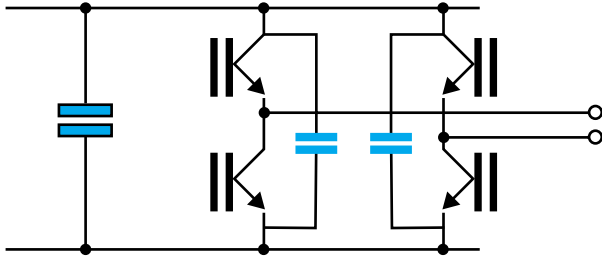
STANDARDS

IEC 1071-1, IEC 1071-2: Power electronic capacitors

TANGENT OF LOSS ANGLE (TANδ₀) FOR POLYPROPYLENE DIELECTRIC

Polypropylene has a constant dielectric loss factor of 2x10⁻⁴ irrespective of temperature and frequency (up to 1 MHz).

IGBT SNUBBER



L = stray inductance IGBT + capacitor

R = serial resistance IGBT + capacitor

$$I_{eff} = \sqrt{\left[\frac{C\beta_0^2 \times U_0}{2j\beta} \right]^2} \times \frac{1}{T} \times \left[\frac{e^{-2\alpha \times T}}{\beta^2 + \alpha^2} \times [\beta \sin(2\beta \times T) - \alpha \times \cos(2\beta \times T)] + \frac{1}{\alpha} \times e^{-2\alpha \times T} + \frac{\alpha}{\beta^2 + \alpha^2} - \frac{1}{\alpha} \right]$$

with $\beta_0 = \sqrt{\frac{1}{LC}}$; $\alpha = \frac{R}{2L}$; $\beta = \sqrt{\beta_0^2 - \alpha^2}$

MARKING

TPC logo

Capacitance and tolerance in clear

Nominal DC voltage in clear

RMS current in clear

Date of manufacture (IEC coding)

HOT SPOT TEMPERATURE CALCULATION

$$\theta_{hot\ spot} = \theta_{ambient} + (P_d + P_t) \times R_{th}$$

with P_d (Dielectric losses) = $Q \times \tan\delta_0$
 $\Rightarrow [\frac{1}{2} \times C_n \times (V_{ripple\ peak\ to\ peak})^2 \times f] \times (2 \times 10^{-4})$
 P_t (Thermal losses) = $R_s \times (I_{rms})^2$
 R_{th} : $R_{th\ ambient} / \text{hot spot}$ in °C/W

where C_n in Farad I_{rms} in Ampere f in Hertz
 V in Volt R_s in Ohm θ in °C

Due to the design of the capacitor and its technology, the thermal impedance between the terminations and the core of the capacitor is low, it is necessary to take care that the capacitor is never overheated by use of wrongly sized connections.

Do not use the capacitor as a heat sink.

Due to the complexity of the IGBT / capacitor thermal exchanges, we recommend that thermal measurements shall be made on the different components. We would be pleased to advise you on specific problems.

WORKING TEMPERATURE

(according to the power to be dissipated) -40°C to +85°C